

Linear Constant Current VCM Driver


BU64241GWZ

General Description

The BU64241GWZ is designed to drive voice coil motor (VCM). The driver includes ISRC (intelligent slew rate control) to reduce mechanical ringing to optimize the camera's auto focus capabilities.

Features

- 2.3 V min driver power supply
- Current sink output
- 10 bit resolution current control
- ISRC mechanical ringing compensation
- 2-wire serial interface
- Integrated current sense resistor

Key Specifications

■ Power supply range	2.3 to 4.8 V
■ Standby current	0 μ A (typ.)
■ Internal resistance	1.5 Ω (typ.)
■ Master clock	400 kHz (typ.)
■ Output maximum current	130 mA (typ.)

Package

UCSP30L1	W (Typ.) x D (Typ.) x H (Max.) 1.30 mm x 0.77 mm x 0.33 mm
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Applications

- Autofocus in mobile camera modules
- Driving VCM actuators

Typical Application Circuit

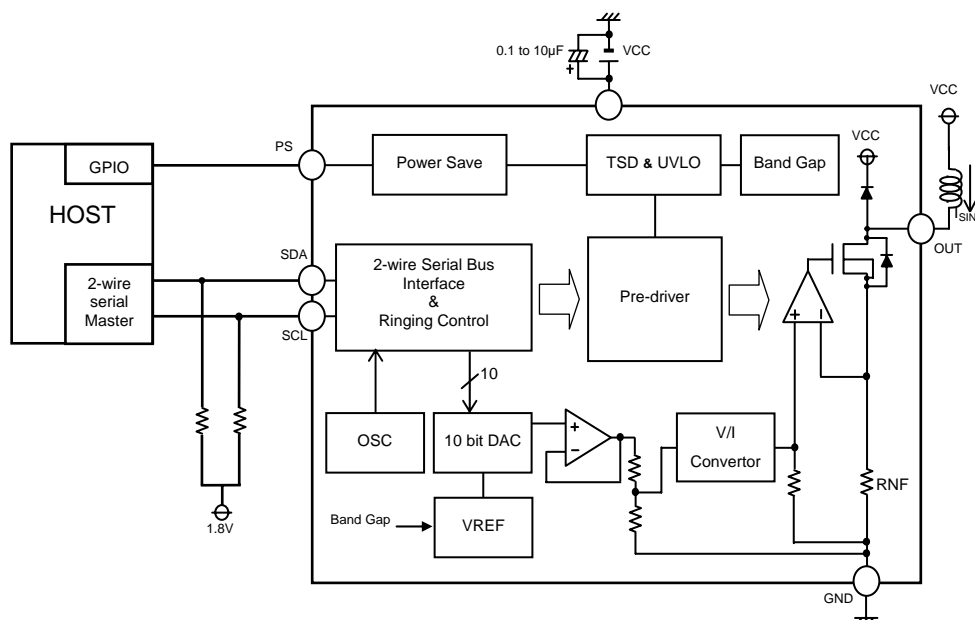


Figure 1. Typical Application Circuit

●Pin Configuration

	1	2	3
A	PS	SDA	SCL
B	OUT	GND	VCC

Figure 2. Pin configuration (TOP VIEW)

●Pin Description

Ball Name	Function
PS	Power save
SDA	Serial data input
SCL	Serial clock input
OUT	Current output
GND	Ground
VCC	Power supply voltage

●Block Diagram

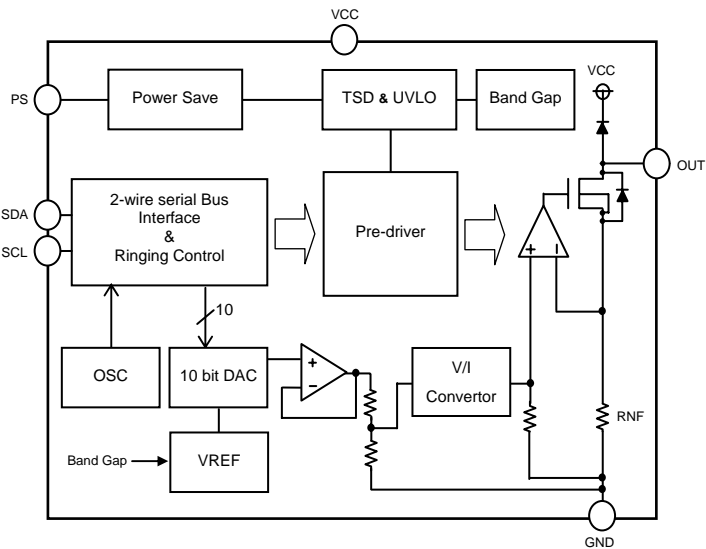


Figure 3. Block Diagram

●Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Power supply voltage	VCC	- 0.5 to + 5.5	V
Power save input voltage	VPS	- 0.5 to + 5.5	V
Control input voltage ^{*1}	VIN	- 0.5 to + 5.5	V
Power dissipation	Pd	220 ^{*2}	mW
Operating temperature range	Topr	- 25 to + 85	°C
Junction temperature	Tjmax	125	°C
Storage temperature range	Tstg	- 55 to + 125	°C
Output current	IOUT	+ 200 ^{*3}	mA

^{*1} VIN is 2-wire serial interface input pins (SCL, SDA)

^{*2} UCSP30L1 package. Reduced by 2.2 mW/°C over 25 °C when mounted on a glass epoxy board (50 mm × 58 mm × 1.75 mm; 8 layers)

^{*3} Must not exceed Pd, ASO, or Tjmax of 125 °C

●Recommended Operating Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit
Power supply voltage	VCC	2.3	3.0	4.8	V
Power save input voltage	VPS	0	-	4.8	V
Control input voltage ^{*1}	VIN	0	-	4.8	V
2-wire serial interface frequency	FCLK	-	-	400	kHz
Output current	IOUT	-	-	130 ^{*4}	mA

^{*1} VIN is 2-wire serial interface input pins (SCL, SDA)

^{*4} Must not exceed Pd, ASO

●Electrical Characteristics (Unless otherwise specified Ta = 25 °C, VCC = 3.0 V)

Parameter	Symbol	Limit			Unit	Conditions
		Min.	Typ.	Max.		
Power Consumption						
Standby current	ICCST	-	0	5	μA	Power save pin = L = VPSL
Circuit current	ICC	-	0.6	1.0	mA	Power save pin = H = VPSH 2-wire serial PS bit = 1, SCL = 400 kHz
Power Save Input (VPS = PS)						
High level input voltage	VPSH	1.26	-	VCC	V	
Low level input voltage	VPSL	0	-	0.5	V	
High level input current	IPSH	- 10	-	10	μA	VPS = 3 V
Low level input current	IPSL	- 10	-	10	μA	VPS = 0 V
Control Input (VIN = SCL, SDA)						
High level input voltage	VINH	1.26	-	VCC	V	
Low level input voltage	VINL	0	-	0.5	V	
Low level output voltage	VINOL	-	-	0.4	V	IIN = + 3.0 mA (SDA)
High level input current	IINH	- 10	-	10	μA	Input voltage = 0.9 x VIN
Low level input current	IINL	- 10	-	10	μA	Input voltage = 0.1 x VIN
Under Voltage Lock Out						
UVLO voltage	VUVLO	1.6	-	2.2	V	
Master Clock						
MCLK frequency	MCLK	- 5	-	5	%	MCLK = 400 kHz
10 Bit D/A Converter (for Controlling Output Current)						
Resolution	DRES	-	10	-	bits	
Differential nonlinearity	DNL	- 1	-	1	LSB	
Integral nonlinearity	INL	- 4	-	4	LSB	
Output Current Performance						
Output current resolution	IORES	-	126	-	μA	Per 1 DAC code step
Output maximum current	IOMAX	117	130	143	mA	DAC_code = 0x3FF
Zero code offset current	IOOFS	0	1	5	mA	DAC_code = 0x000
Output voltage	VOUT	-	150	200	mV	Output current = 100 mA
Maximum applied voltage	VOMAX	-	-	VCC	V	
Output resistance	ROUT	-	1.5	2.0	Ω	

●Typical Performance Curves

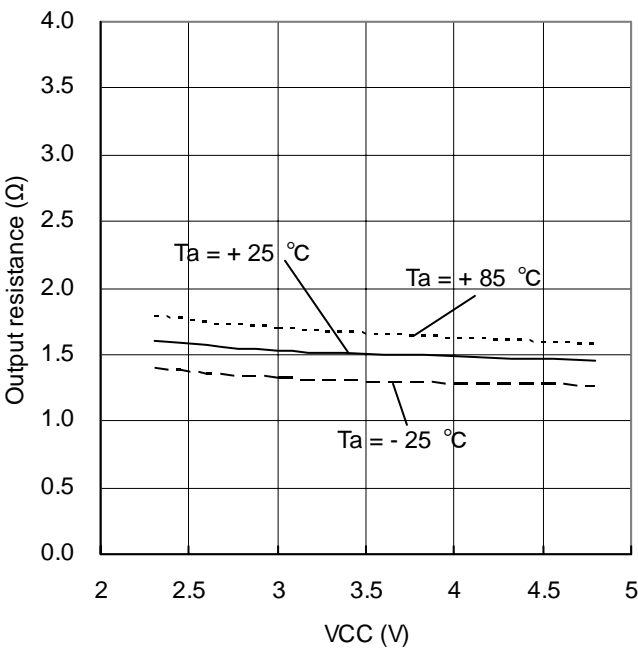


Figure 4. Output resistance

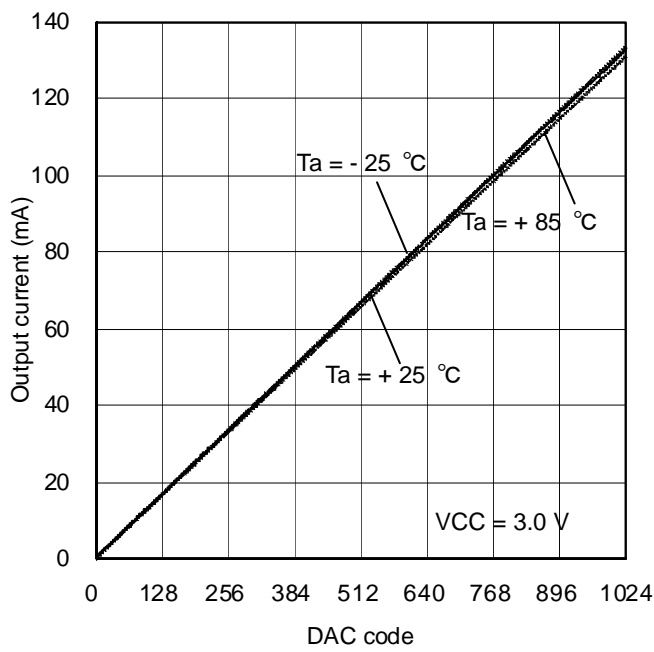


Figure 5. Output current vs. DAC code

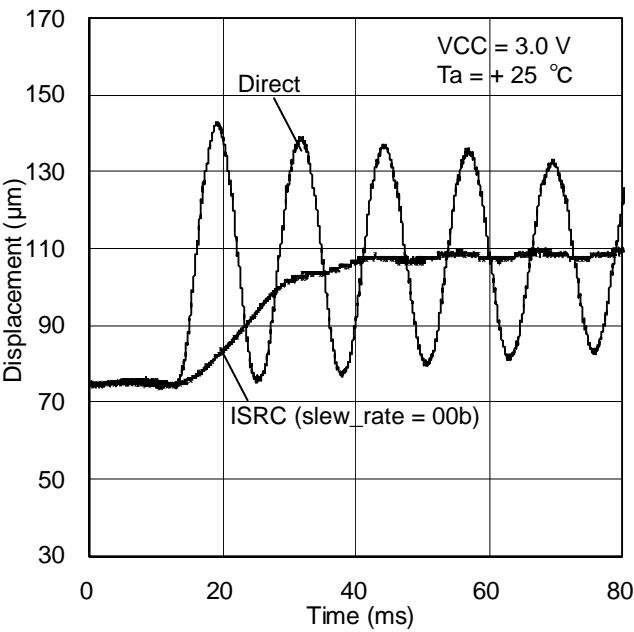


Figure 6. Displacement vs. settling time (slew_rate = 00b)

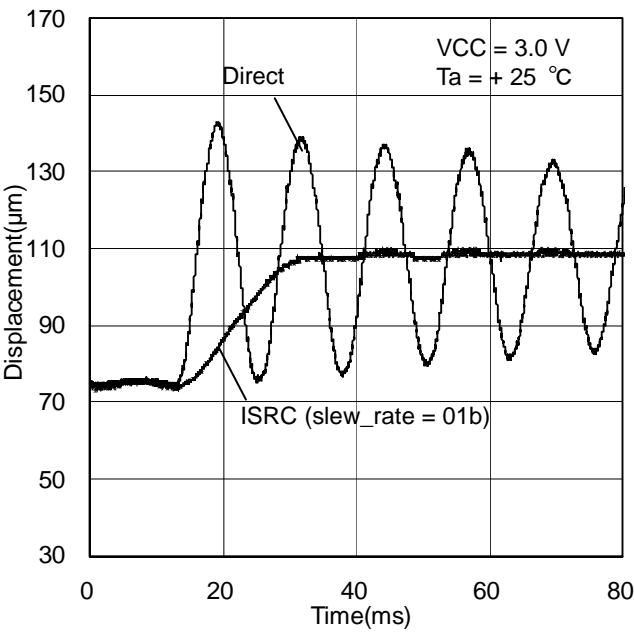


Figure 7. Displacement vs. settling time (slew_rate = 01b)

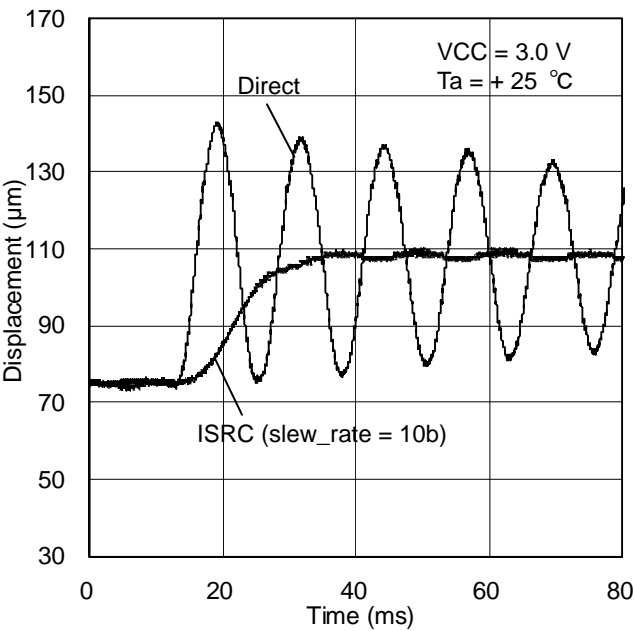


Figure 8. Displacement vs. settling time (slew_rate = 10b)

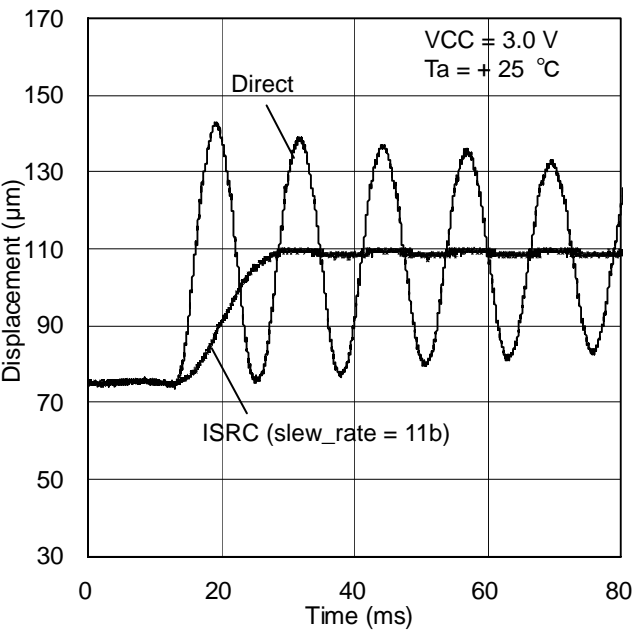
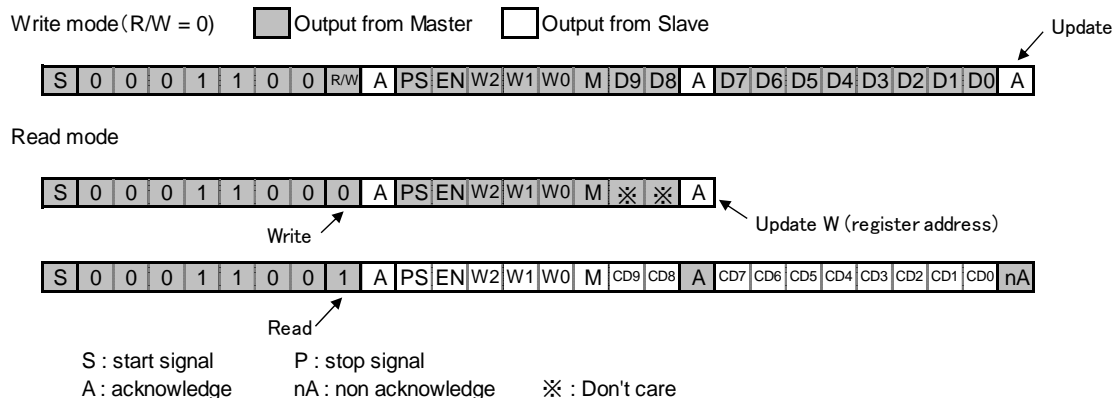


Figure 9. Displacement vs. settling time (slew_rate = 11b)

●2-wire serial BUS Format (Fast mode SCL = 400 kHz)



Register name	Setting item	Description
R/W	Read/Write mode	0 = Write mode (0x18 address), 1 = Read mode (0x19 address)
PS	Serial power save	0 = Driver in standby mode, 1 = Driver in operating mode
EN	Driver output status	0 = Output is Hi-Z 1 = Constant current sink/sequence start
M	Mode select	M=0=ISRC mode disabled M=1=ISRC mode enabled
W2W1W0	Register address	000b = Output current setting
		001b = Parameter setting 1
		010b = Parameter setting 2
		011b = Parameter setting 3
		100b = Parameter setting 4
D9 to D0	Data bits	Register data

●Register Update Timing

PS – Register is updated during the 2nd ACK response during a 3 byte 2-wire serial command

EN – Register is updated during the 3rd ACK response during a 3 byte 2-wire serial command

Wx – Register is updated during the 2nd ACK response during a 3 byte 2-wire serial command

M – Register is updated during the 3rd ACK response during a 3 byte 2-wire serial command

Dx – Register is updated during the 3rd ACK response during a 3 byte 2-wire serial command

Note: Setting the external power save pin = VPSL (typically 0 V) will reset all 2-wire serial registers to 0

●Register Map

Address	Bit	Bit Name	Function
000b	D[9:0]	C_DAC[9:0]	Point C DAC code setting[9:0]
001b	D[9:8]		
	D[7:3]	rf[4:0]	Resonant frequency setting[4:0]
	D2		
	D[1:0]	slew_rate[1:0]	Slew rate speed setting[1:0]
010b	D[9:0]	A_DAC[9:0]	Point A DAC code setting[9:0]
011b	D[9:0]	B_DAC[9:0]	Point B DAC code setting[9:0]
100b	D[9:8]		
	D[7:5]	str[2:0]	Step resolution setting[2:0]
	D[4:0]	stt[4:0]	Step time setting[4:0]

● Characteristics of the SDA and SCL Bus Lines for 2-wire Serial Interface (Ta = - 25 to +85 °C, VCC = 2.3 to 4.8 V)

Parameter	Symbol	STANDARD-MODE ^{*5}		FAST-MODE ^{*5}		Unit
		Min.	Max.	Min.	Max.	
Pulse width of spikes which must be suppressed by the input filter	tSP	0	50	0	50	ns
Hold time (repeated) start condition. The first clock pulse is generated after this period.	tHD;STA	4.0	-	0.6	-	μs
Low period of the SCL clock	tLOW	4.7	-	1.3	-	μs
High period of the SCL clock	tHIGH	4.0	-	0.6	-	μs
Set-up time for repeated START condition	tSU;STA	4.7	-	0.6	-	μs
Data hold time	tHD;DAT	0	3.45	0	0.9	μs
Data set-up time	tSU;DAT	250	-	100	-	ns
Set-up time for stop condition	tSU;STO	4.0	-	0.6	-	μs
Bus free time between a stop and start condition	tBUF	4.7	-	1.3	-	μs

^{*5} STANDARD-MODE and FAST-MODE 2-wire serial interface devices must be able to transmit or receive at the designated speed.
The maximum bit transfer rates are 100 kbit/s for STANDARD-MODE devices and 400 kbit/s for FAST-MODE devices.
This transfer rates is based on the maximum transfer rate. For example the bus is able to drive 100 kbit/s clocks with FAST-MODE.

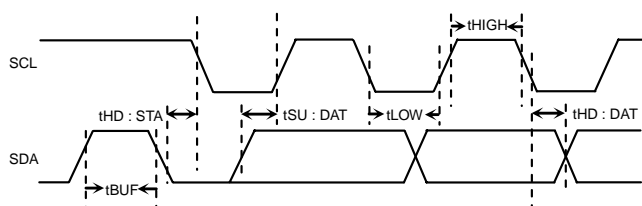
● 2-wire Serial Interface Timing


Figure 10. Serial Data Timing

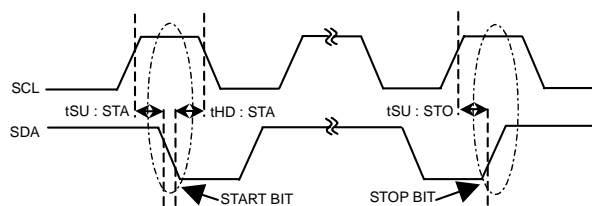


Figure 11. Start and Stop Bit Timing

● Initialization Sequence

Item	Symbol	Min.	Typ.	Max.	Unit
Setup time for external power save pin	tPS;r	0	-	-	μs
Hold time for external power save pin	tPS;f	0	-	-	μs
2-wire serial data start time	ti2c;s	15	-	-	μs
2-wire serial data stop time	ti2c;p	1.3	-	-	μs

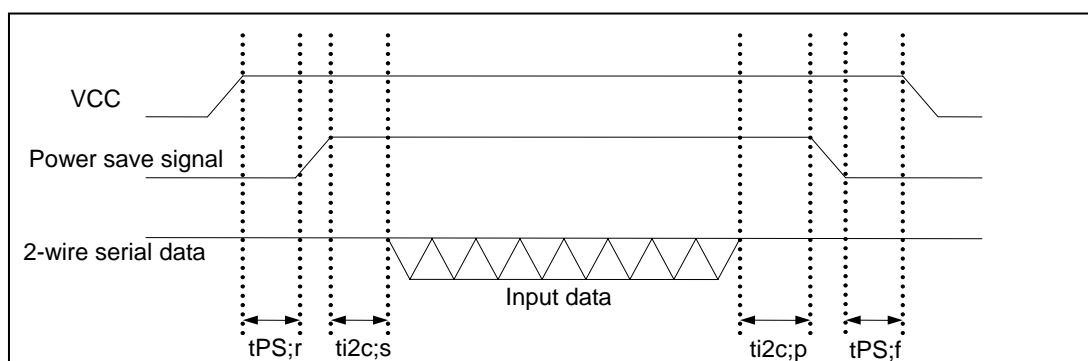


Figure 12. Timing Between Applying Power (VCC) Until Input of Serial Data

●Power Dissipation

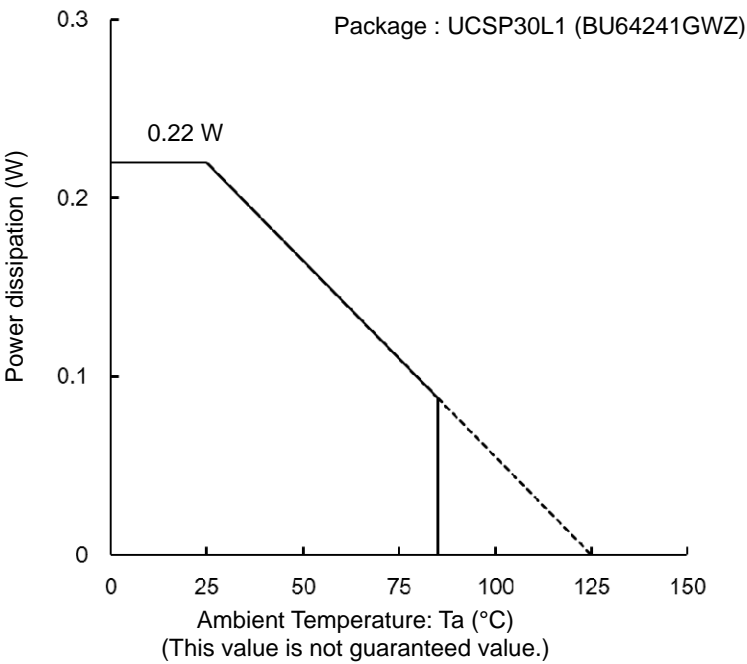
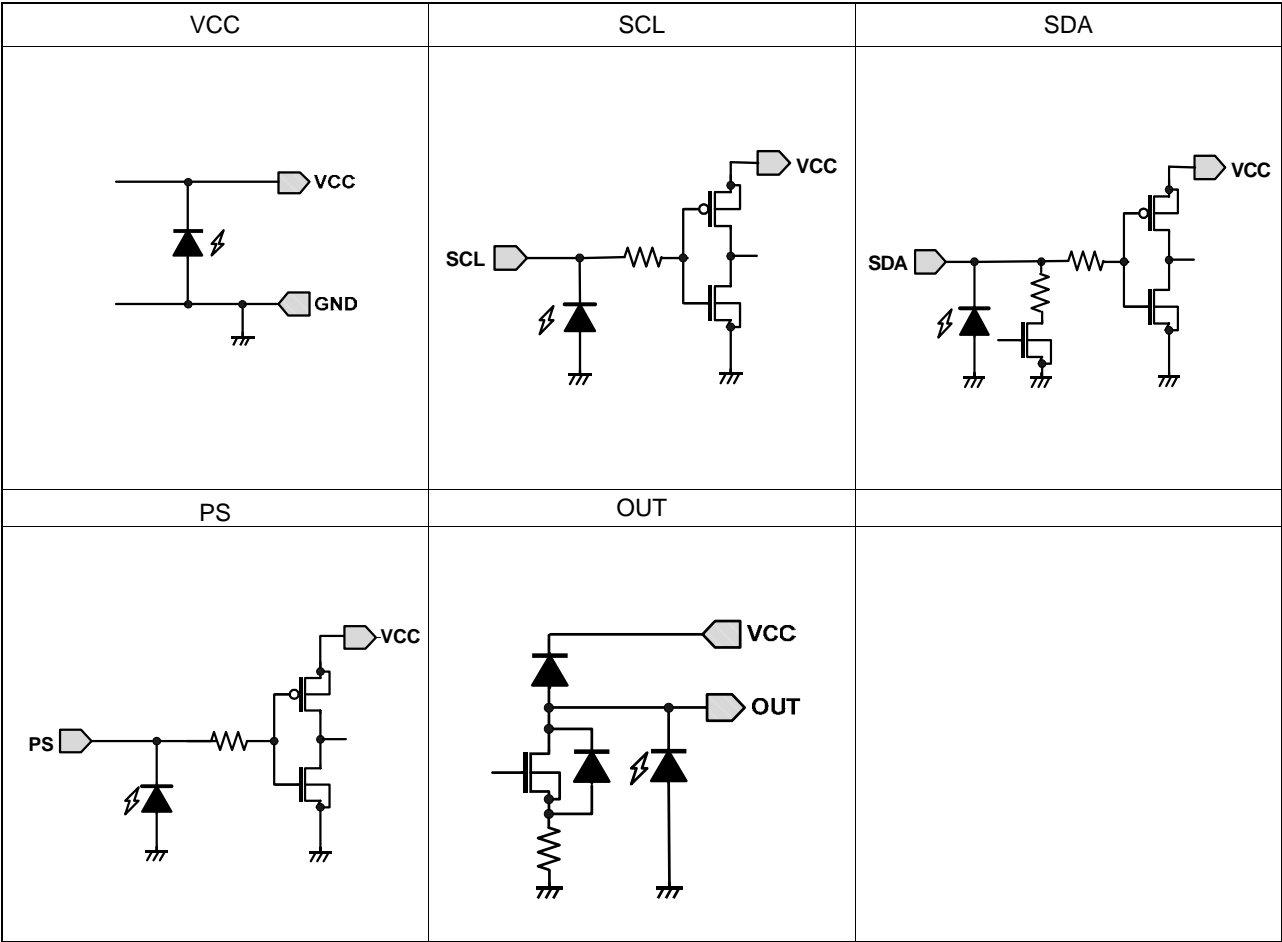


Figure 13. Power dissipation Pd (W)

●I/O equivalence circuit



●Controlling Mechanical Ringing

A voice coil motor (VCM) is an actuator technology that is intrinsically noisy due to the properties of the mechanical spring behavior. As current passes through the VCM, the lens moves and oscillates until the system reaches a steady state. The BU64241GWZ lens driver is able to control mechanical oscillations by using the integrated ISRC (intelligent slew rate control) function. ISRC is operated by setting multiple control parameters that are determined by the intrinsic characteristics of the VCM. The following steps illustrate how to best utilize ISRC to minimize mechanical oscillations.

• Step A1 – Determining the Resonant Frequency of the VCM

Each VCM has a resonant frequency that can either be provided by the manufacturer or measured. The resonant frequency of an actuator determines the amount of ringing (mechanical oscillation) experienced after the lens has been moved to a target position and the driver output current held constant. To determine the resonant frequency, f_0 , input a target DAC code by modifying the 10 bit C_DAC[9:0] value in register W2W1W0 = 000b that will target a final lens position approximately half of the actuator's full stroke. Take care to not apply too much current so that the lens does not hit the mechanical end of the actuator as this will show an incorrect resonant period. In order to start movement of the lens to the DAC code that was set in C_DAC[9:0], the EN bit must be set to 1.

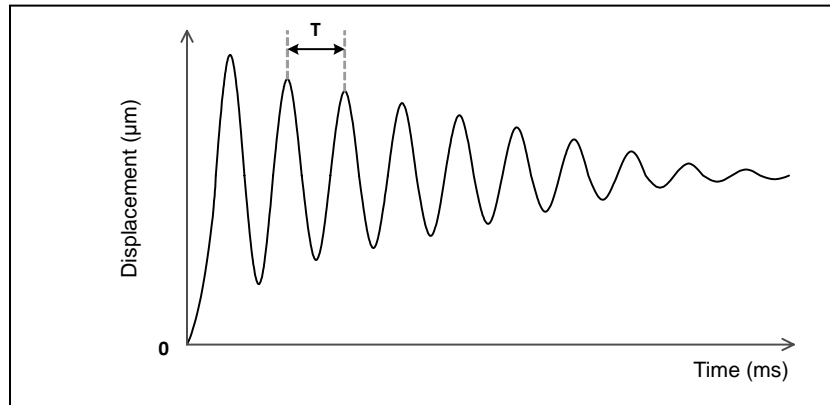


Figure 14. Actuator Displacement Waveform (ISRC Disabled)

The resonant frequency (Hz) of the actuator can be calculated with Equation 1 using the resonant period observed in Figure 14.

$$f_0 = (T)^{-1}$$

Equation1. Resonant Frequency vs. Time Period Relationship

After calculating the correct resonant frequency, program the closest value in the W2W1W0 = 001b register using the 5 bit rf[4:0] values from Table 1. When calculating the resonant frequency take care that different actuator samples' resonant frequencies might vary slightly and that the frequency tolerance should be taken into consideration when selecting the correct driver resonant frequency value.

Table 1. f_0 Settings (rf[4:0])

rf[4:0]	f_0	rf[4:0]	f_0	rf[4:0]	f_0	rf[4:0]	f_0
00000	-	01000	85 Hz	10000	125 Hz	11000	-
00001	50 Hz	01001	90 Hz	10001	130 Hz	11001	-
00010	55 Hz	01010	95 Hz	10010	135 Hz	11010	-
00011	60 Hz	01011	100 Hz	10011	140 Hz	11011	-
00100	65 Hz	01100	105 Hz	10100	145 Hz	11100	-
00101	70 Hz	01101	110 Hz	10101	150 Hz	11101	-
00110	75 Hz	01110	115 Hz	10110	-	11110	-
00111	80 Hz	01111	120 Hz	10111	-	11111	-

• Step A2 – Selecting the Autofocus Algorithm's Target DAC Codes

The ISRC algorithm is a proprietary technology developed to limit the ringing of an actuator by predicting the magnitude of ringing created by an actuator and intelligently controlling the output signal of the driver to minimize the ringing effect. Due to the ringing control behavior of ISRC, it is unable to operate properly unless the lens is floating (lens lifted off of the mechanical end of the actuator). As such the ringing control behavior is broken into three separate operational areas in order to provide the most optimally controlled autofocus algorithm.

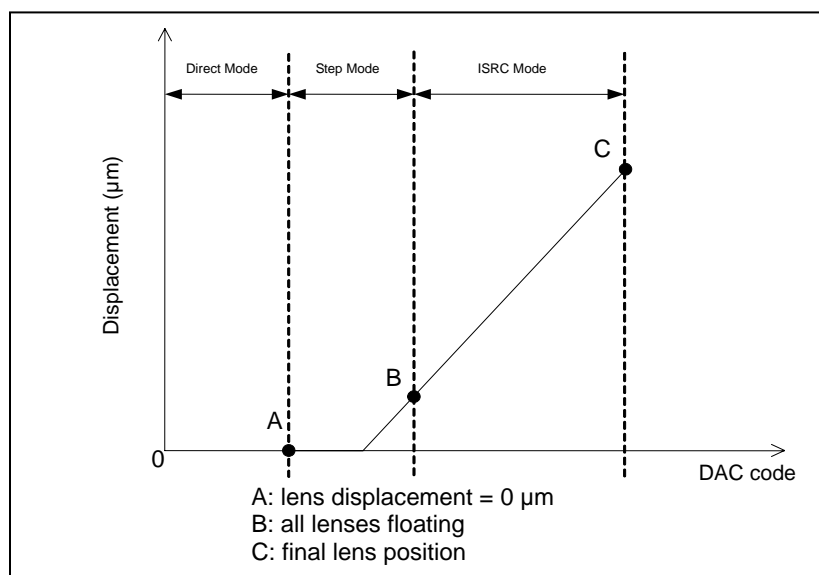


Figure 15. Lens Displacement vs. DAC Code

Figure 15 illustrates the different operational modes that control the autofocus algorithm. Due to ISRC requiring a floating lens, points A and B need to be set in order to create a floating condition. Point A corresponds to the maximum amount of current that can be applied to all VCM units without floating the lens. Point B corresponds to the minimum amount of current that can be applied to the VCM so that all actuator units are floating. It should be noted that the target DAC codes could vary between different actuator units and that sufficient evaluation should be performed before selecting the point A and B target DAC codes. Point C is the final lens target position determined by the level of focus required for the image capture.

The actuator manufacturer should be able to provide the required current for points A and B, however it is possible to test these points by slowly increasing the 10 bit value of C_DAC[9:0] and measuring the lens movement using a laser displacement meter or some other device to measure lens displacement.

●Controlling the Driver

After following steps A1 and A2 to characterize the VCM performance, the following steps should be followed in order to properly control the driver settings for optimized autofocus performance.

• Step B1 – Setting Point A, B, and C DAC Codes

Points A, B, and C are defined by 10 bit DAC codes set with the following registers:

Location	W2W1W0 Register	DAC Code Location	Description
Point C	000b	C_DAC[9:0]	Final lens position before image capture
Point A	010b	A_DAC[9:0]	Maximum output current without floating the lens
Point B	011b	B_DAC[9:0]	Minimum output current required to float the lens

• Step B2 – Controlling Direct Mode

Direct mode is when the driver outputs the desired amount of output current with no output current control. The time in which the lens reaches the position that corresponds to the amount of output current set by the 10 bit DAC code is ideally instant, ignoring the ringing effects. If the driver is set so that the lens is moved from a resting position to point C with direct mode, ringing and settling time will be at a maximum.

Direct mode is used either when M = 0 or when M = 1 and the present DAC code is less than the DAC code of point A.

M = 0 = ISRC mode disabled

When ISRC mode is disabled by setting the M bit equal to 0, the lens will traverse to the DAC code set for point C when the EN bit is set equal to 1.

M = 1 = ISRC mode enabled

The driver automatically uses direct mode if the present DAC code is less than the target DAC code corresponding to point A. Therefore during ISRC operation when the autofocus sequence has been started by setting the EN bit equal to 1, the driver will automatically decide to use direct mode to output current up to point A and then switch to step mode before continuing the autofocus sequence.

• Step B3 – Controlling Step Mode

Step mode is the control period in which the lens is moved by small output current steps. During step mode it is possible to control the step resolution and step time in order to generate just enough output current to float the lens with minimal ringing effects. Ringing can be better controlled by choosing a large value for the step time and a small value for the step resolution with the trade off of a greater settling time. The step time and step resolution should be chosen depending on the acceptable system limits of ringing vs. settling time.

Step mode is used when $M = 1$ and the present DAC code is in between point A and point B. Typically this mode is only used during ISRC operation between point A and B, however it is possible to move the lens to point C using only step mode if point C is set such that point C is only 1 DAC code greater than point B.

Step mode is controlled by the 5 bit step time, $stt[4:0]$, and 3 bit step resolution, $str[2:0]$, values stored in register $W2W1W0 = 100b$.

Table 2. Step Time Settings

$stt[4:0]$	Step Time	$stt[4:0]$	Step Time	$stt[4:0]$	Step Time	$stt[4:0]$	Step Time
00000	-	01000	400 μs	10000	800 μs	11000	1200 μs
00001	50 μs	01001	450 μs	10001	850 μs	11001	1250 μs
00010	100 μs	01010	500 μs	10010	900 μs	11010	1300 μs
00011	150 μs	01011	550 μs	10011	950 μs	11011	1350 μs
00100	200 μs	01100	600 μs	10100	1000 μs	11100	1400 μs
00101	250 μs	01101	650 μs	10101	1050 μs	11101	1450 μs
00110	300 μs	01110	700 μs	10110	1100 μs	11110	1500 μs
00111	350 μs	01111	750 μs	10111	1150 μs	11111	1550 μs

Table 3. Step Resolution Settings

$str[2:0]$	Step Resolution	$str[2:0]$	Step Resolution	$str[2:0]$	Step Resolution	$str[2:0]$	Step Resolution
000	-	010	2 LSB	100	4 LSB	110	6 LSB
001	1 LSB	011	3 LSB	101	5 LSB	111	7 LSB

• Step B4 – Controlling ISRC Mode

ISRC mode is the control period in which the lens is already floating and the driver smoothly moves the lens based on the proprietary behavior of the ISRC algorithm. ISRC operation keeps ringing at a minimum while achieving the fastest possible settling time based on the ISRC operational conditions.

ISRC mode is used when $M = 1$ and the present DAC code is greater than the DAC code for point B. If the target DAC code for point C is set so that the value is too large and will cause excess ringing, the point C DAC code is automatically updated with a driver pre-determined value to minimize the ringing effect. When $M = 1$, the driver will automatically switch between direct mode, step mode, and ISRC mode when the point A, point B, and point C DAC code conditions are met. The condition for this automatic transitioning to occur is when the register values for point A, point B, point C, step time, and step resolution are all set to values other than 0 and then the sequence will start when the EN bit is set equal to 1.

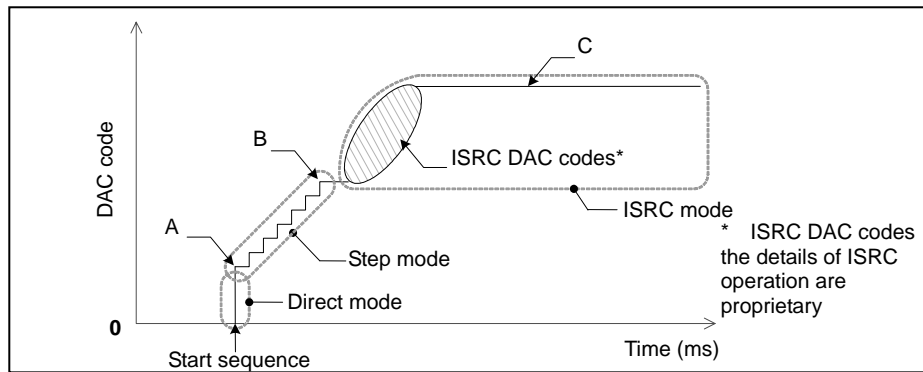


Figure 16. Three Modes Sequential Operation (Shown as DAC Codes)

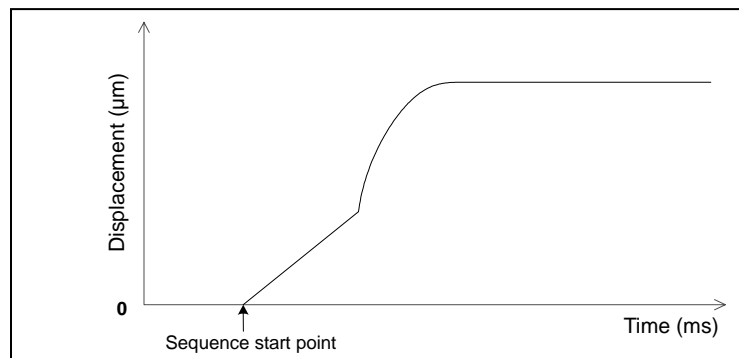


Figure 17. Three Modes Sequential Operation (Shown as Lens Displacement)

• Step B5 – Controlling the ISRC Settling Time

The settling time of an actuator is the time it takes for ringing to cease. The BU64241GWZ is able to control the settling time by modifying the slew rate speed parameter, however care must be taken to balance settling time vs. acceptable ringing levels. By increasing the slew rate speed there is the possibility to decrease the settling time but the ability to control ringing is also decreased. Likewise if less ringing is desired then there is a possibility to reduce the ringing level by using a slower slew rate speed setting at the cost of a longer settling time. The slew rate speed can be set by modifying the 2 bit `slew_rate[1:0]` value in register `W2W1W0 = 001b`. Figure 18 shows the relationship of displacement vs. settling time.

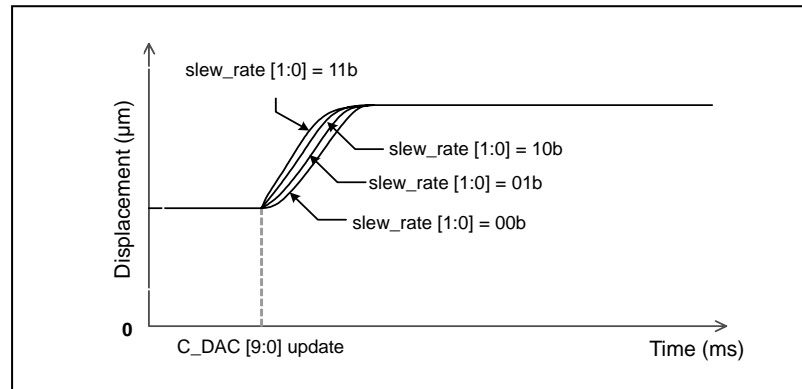


Figure 18. Displacement vs. Settling Time

Table 4. Slew Rate Speed Settings

<code>slew_rate[1:0]</code>	Slew Rate Speed	<code>slew_rate[1:0]</code>	Slew Rate Speed	<code>slew_rate[1:0]</code>	Slew Rate Speed	<code>slew_rate[1:0]</code>	Slew Rate Speed
00	Slowest	01	Slow	10	Fast	11	Fastest

• Step B6 – DAC Code Update Timing Considerations

Settling time is controlled by the resonant frequency of the actuator and the driver's slew rate speed setting. Depending on the combination of these parameters, the settling time can be such that updating point C with a new DAC code before the lens has settled at the original point C DAC code can adversely affect the settling time due to increased ringing effects. Utilize the slew rate speed parameter in order to modify the settling time so that any updates to the point C DAC code do not occur before the lens has settled.

Please review the following example based on an actuator with a resonant frequency of 100 Hz:

Table 5. Relationship Between Slew Rate Speed and Settling Time Based on a 100 Hz Actuator

f_0	slew_rate[1:0]	Settling Time
100 Hz	00	52 ms
	01	42 ms
	10	26 ms
	11	18 ms

In this example the settling time of the actuator can vary by up to $\pm 5\%$ due to the internal oscillator (MCLK) having a variance of $\pm 5\%$. The settling time has a proportionally inverse relationship to the resonant frequency and therefore the settling time can be estimated as:

Table 6. Relationship Between Slew Rate Speed and Settling Time Based on a General Resonant Frequency f_0'

f_0'	slew_rate[1:0]	Settling Time
f_0' Hz	00	$52 * (100 / f_0')$ ms
	01	$42 * (100 / f_0')$ ms
	10	$26 * (100 / f_0')$ ms
	11	$18 * (100 / f_0')$ ms

Note that the orientation of the camera module can affect the settling time due to the influence of gravity on the lens.

• Step C1 – Power Save Operation

The BU64241GWZ can be set to enter power save mode either by setting the external power save pin = VPSEL (typically 0 V) or by setting the 2-wire serial PS bit = 0. It is recommended to use the external power save pin method since this will disable the internal MCLK to achieve lower power consumption while in standby mode. Please note that setting the external power save pin = VPSEL will reset all 2-wire serial registers to 0.

●Operational Notes

(1) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings such as the applied voltage or operating temperature range (Topr) may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is incurred. The implementation of a physical safety measure such as a fuse should be considered when there is use of the IC in a special mode where it's anticipated that the absolute maximum ratings may be exceeded.

(2) Power supply lines

Regenerated current may flow as a result of the motor's back electromotive force. Insert capacitors between the power supply and ground pins to serve as a route for regenerated current. Determine the capacitance based on of all the characteristics of an electrolytic capacitor due to the electrolytic capacitor possibly losing some capacitance at low temperatures. If the connected power supply does not have sufficient current absorption capacity, regenerative current will cause the voltage on the power supply line to rise, which combined with the product and its peripheral circuitry may exceed the absolute maximum ratings. It is recommended to implement a physical safety measure such as the insertion of a voltage clamp diode between the power supply and GND pins.

(3) Heat dissipation

Use a thermal design that allows for a sufficient margin regarding the power dissipation (Pd) during actual operating conditions.

(4) Use in strong magnetic fields

Use caution when using the IC in the presence of a strong magnetic field as doing so may cause the IC to malfunction.

(5) ASO

When using the IC, set the output transistor for the motor so that it does not exceed absolute maximum ratings or ASO.

(6) Thermal shutdown circuit

This IC incorporates a TSD (thermal shutdown) circuit. If the temperature of the chip reaches the below temperature, the motor coil output will be opened. The thermal shutdown circuit (TSD circuit) is designed only to shut off the IC to prevent runaway thermal operation. It is not designed to protect the IC or to guarantee its operation. Do not continue to use the IC after use of the TSD feature or use the IC in an environment where the its assumed that the TSD feature will be used.

TSD ON temperature [°C] (Typ.)	Hysteresis temperature [°C] (Typ.)
150	20

(7) Ground Wiring Pattern

Ensure a minimum GND pin potential in all operating conditions.

When using GND patterns for both small signal and large currents, it is recommended to isolate the two ground patterns by placing a single ground point at the application's reference point. This will help to alleviate noise in the small signal ground voltage due to noise created by the ground pattern wiring resistance for large current blocks. Be careful not to change the GND wiring pattern of any external components.

(8) Power Save (PS) terminal

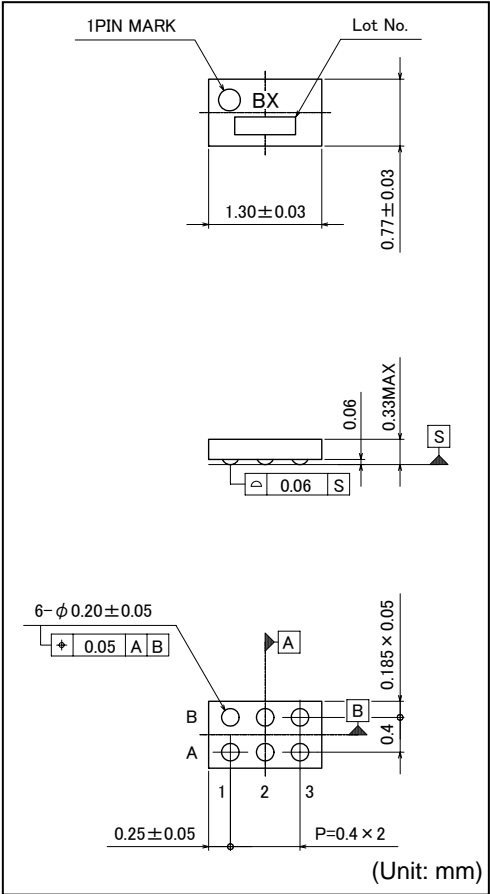
PS holds the reset function on logic concurrently. Please release PS after the start-up of VCC. Reset is not normally done when VCC is short-circuited to PS and it uses it, and there is a possibility of malfunctions.

●Ordering Part Number

B U 6 4 2 4 1 G W Z										E2	
Part Number										Packaging and forming specification	
Package GWZ: UCSP30L1										E2: Embossed tape and reel	

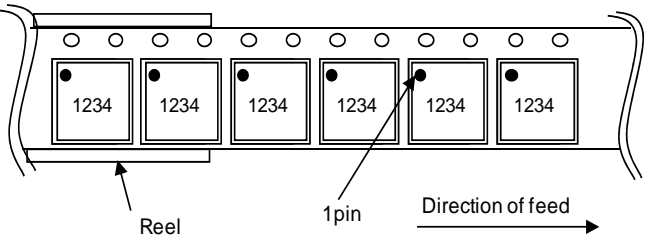
●Physical Dimension Tape and Reel Information

UCSP30L1 (BU64241GWZ)



<Packing specification>

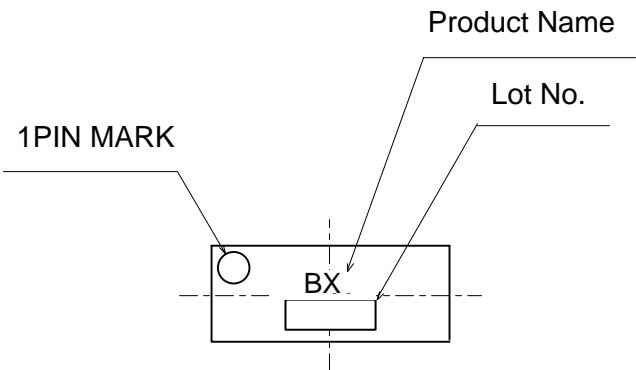
Tape	Embossed carrier tape
Quantity	6,000 pcs / reel
Direction of feed	E2 (See neighboring image)



*Order quantity needs to be multiple of the minimum quantity.

●Marking Diagram(TOP VIEW)

UCSP30L1 (BU64241GWZ)



●Revision History

Date	Revision	Changes
15.Oct.2012	001	New Release
11.Apr.2013	002	Add information about "BU64243GWZ".
31.May.2013	003	Delete information about "BU64240GWZ".
01.Jul.2013	004	Delete information about "BU64243GWZ".

Notice

Precaution on using ROHM Products

- Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

- ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

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Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331